

**Features:**

- Isolated mounting base 3000V~
- Solder joint technology with increased power cycling capability
- Space and weight saving

Typical Applications:

- AC/DC Motor drives
- Various rectifiers
- DC supply for PWM inverter

V _{DRM} , V _{RRM}	Type & Outline		
	600V	800V	1000V
1200V	MTC70-06-224H3/224H3B	MTC70-08-224H3/224H3B	MTC70-10-224H3/224H3B
1400V	MTC70-12-224H3/224H3B	MTC70-14-224H3/224H3B	MTC70-16-224H3/224H3B
1600V	MTC70-18-224H3/224H3B		
1800V			

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT
				Min	Type	Max	
I _{T(AV)}	Mean on-state current	180° half sine wave 50Hz Single side cooled, T _c =85°C	125			70	A
I _{T(RMS)}	RMS on-state current		125			110	A
I _{DRM} I _{RRM}	Repetitive peak current	at V _{DRM} at V _{RRM}	125			15	mA
I _{TSM}	Surge on-state current	10ms half sine wave V _R =60%V _{RRM}	125			1.8	kA
I ² t	I ² t for fusing coordination					16.2	A ² s*10 ³
V _{TO}	Threshold voltage	I _{TM} =210A	125			0.75	V
r _T	On-state slope resistance					3.64	mΩ
V _{TM}	Peak on-state voltage	I _{TM} =210A	25			1.80	V
dv/dt	Critical rate of rise of off-state voltage	V _{DM} =67%V _{DRM}	125			1000	V/μs
di/dt	Critical rate of rise of on-state current	Gate source 1.5A t _r ≤0.5μs Repetitive	125			200	A/μs
I _{GT}	Gate trigger current	V _A =12V, I _A =1A	25	30		200	mA
V _{GT}	Gate trigger voltage			0.6		2.5	V
I _H	Holding current			10		250	mA
I _L	Latching current					1000	mA
V _{GD}	Non-trigger gate voltage	V _{DM} =67%V _{DRM}	125			0.2	V
R _{th(j-c)}	Thermal resistance Junction to case	Single side cooled, per chip				0.35	°C /W
R _{th(c-h)}	Thermal resistance case to heatsink	Single side cooled, per chip				0.15	°C /W
V _{iso}	Isolation voltage	50Hz,R.M.S,t=1min,I _{iso} :1mA(MAX)		3000			V
F _m	Thermal connection torque(M5)			2.5		4.0	N·m
	Mounting torque(M6)			4.0		6.0	N·m
T _{vj}	Junction temperature			-40		125	°C
T _{stg}	Stored temperature			-40		125	°C
W _t	Weight				100		g
Outline		224H3、224H3B					

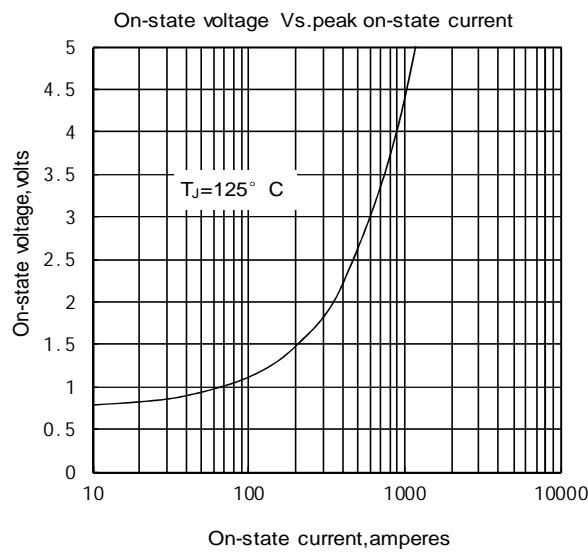


Fig1

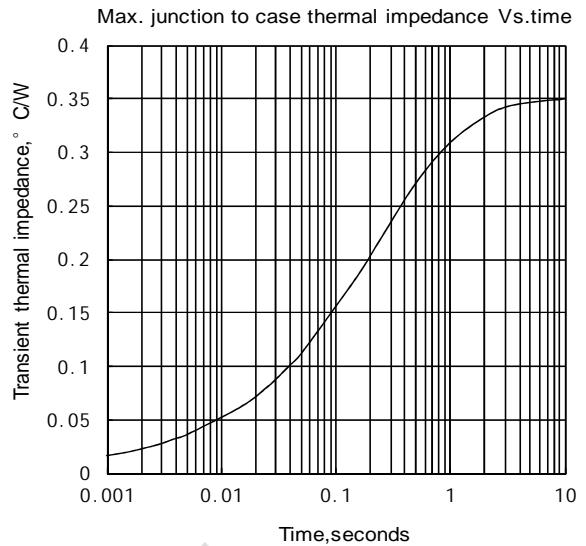


Fig2

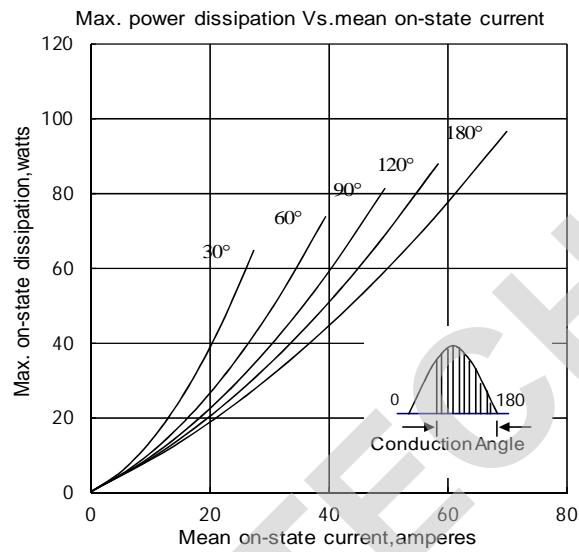


Fig3

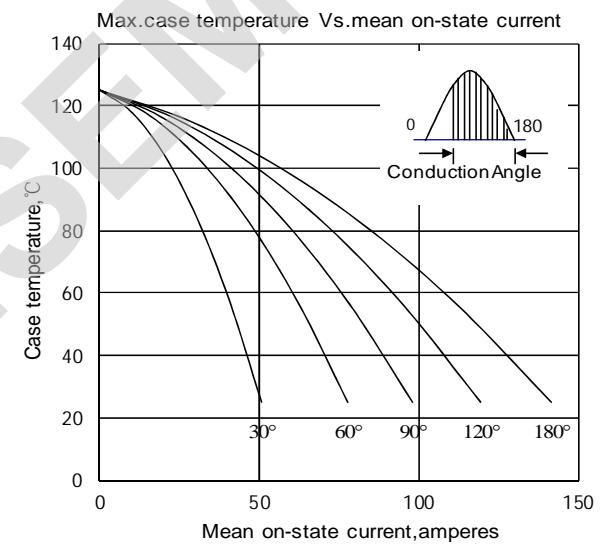


Fig4

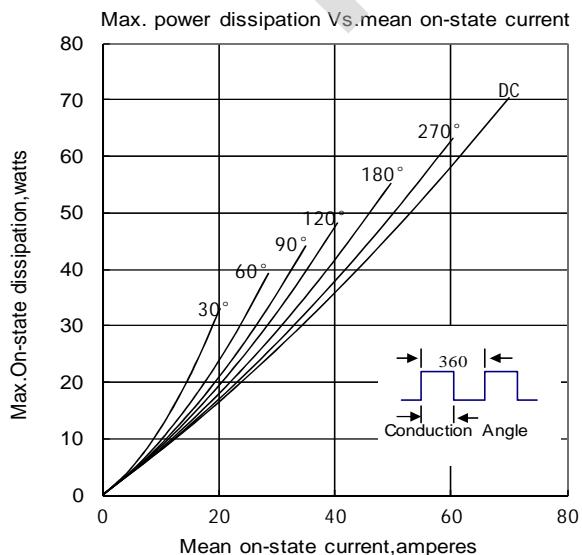


Fig5

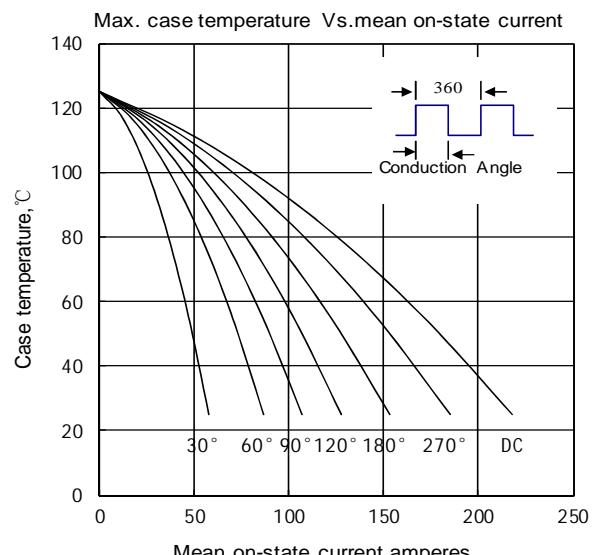


Fig6

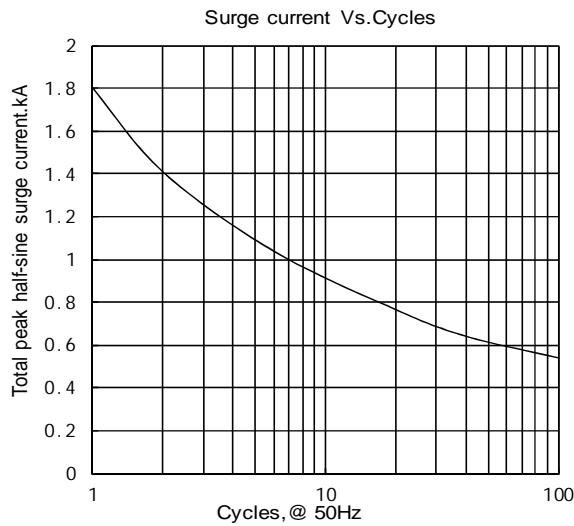


Fig7

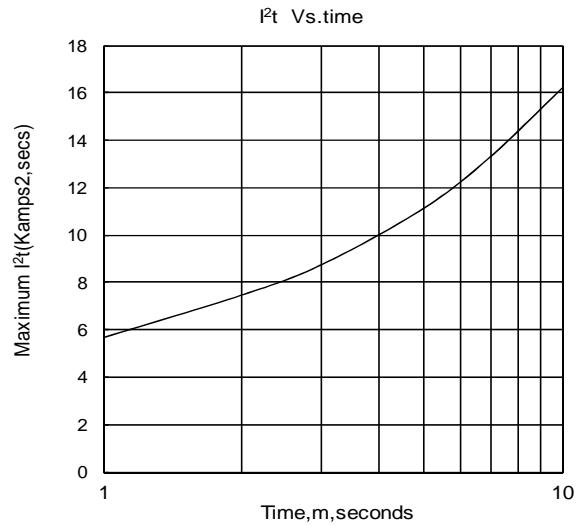


Fig8

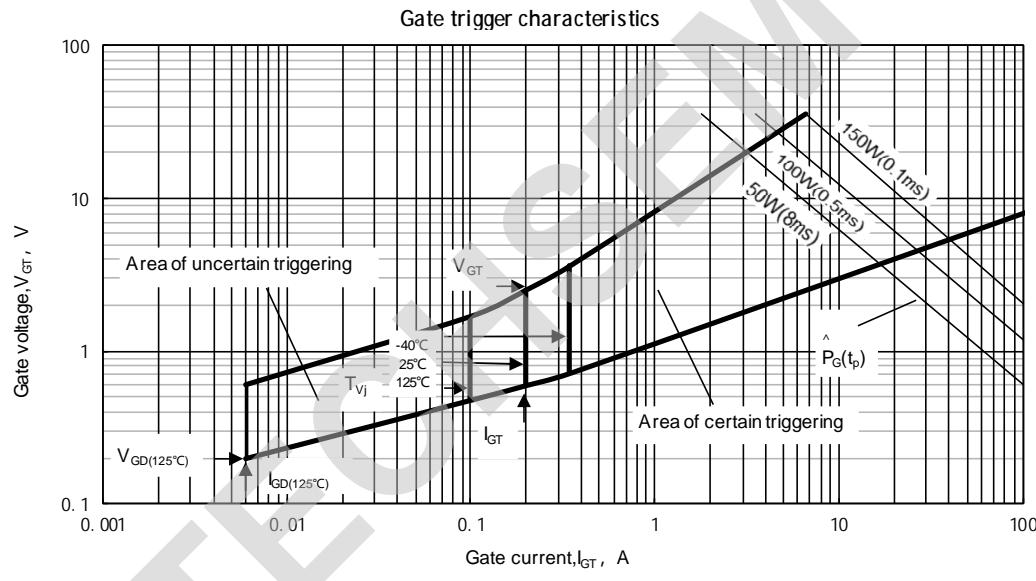
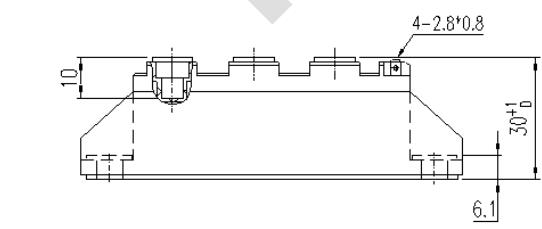
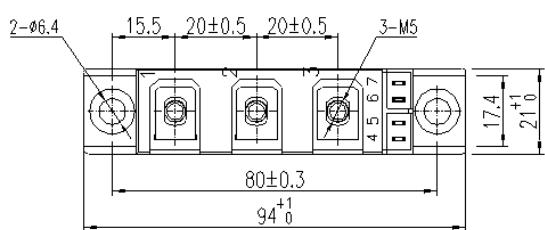
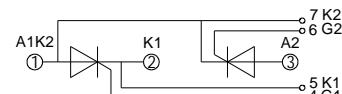


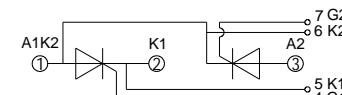
Fig9

Outline:

MTC



MTC(B)

Unmarked dimensional tolerance: $\pm 0.5\text{mm}$

TECHSEM reserves the right to change specifications without notice.